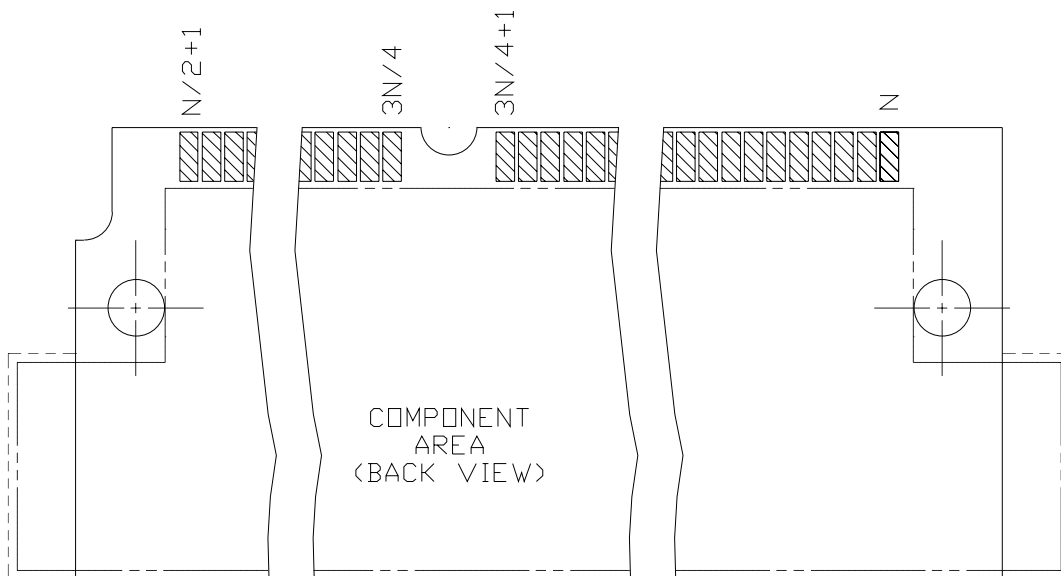
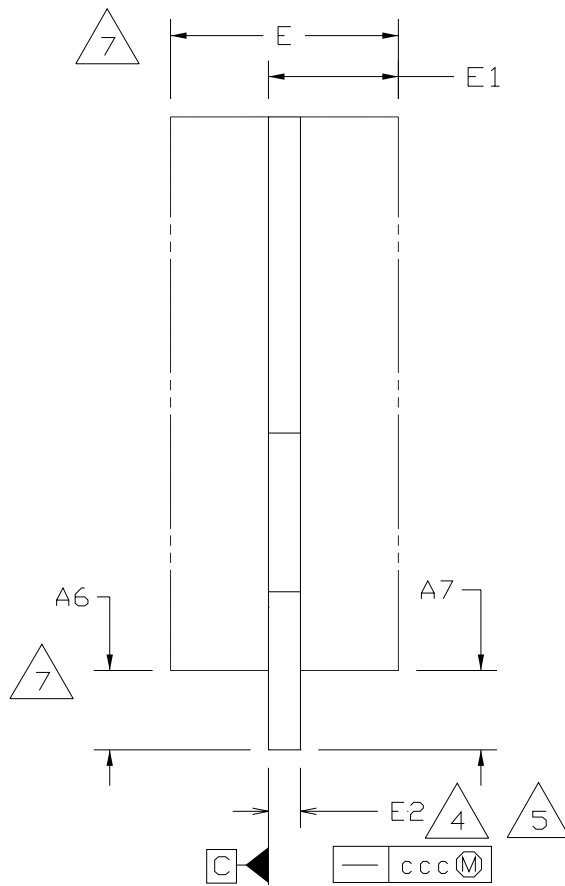


JEDEC SOLID STATE PRODUCT OUTLINES	THIS REGISTERED OUTLINE HAS BEEN PREPARED BY THE JEDEC JC-11 COMMITTEE AND REFLECTS A PRODUCT WITH ANTICIPATED USAGE IN THE ELECTRONICS INDUSTRY; CHANGES ARE LIKELY TO OCCUR.				
TITLE PLUGGABLE DUAL INLINE MODULE, 127 LEAD CENTERS	JESD-30 DESIGNATOR	ISSUE C	DATE SEPT 97	MO-167	SHEET 1 OF 4



COMMON DIMENSIONS					COMMON DIMENSIONS				
SYMBOL	ALL DIMENSIONS IN MILLIMETERS				SYMBOL	ALL DIMENSIONS IN MILLIMETERS			
	MINIMUM	NOMINAL	MAXIMUM	NOTE		MINIMUM	NOMINAL	MAXIMUM	NOTE
A	25.27	25.40	25.53	8	E1	--	--	5.28	4
A1	12.70	--	--		E2	1.17	1.27	1.37	
A2		10.16 BSC			F	3.13	3.18	3.23	
A3	6.22	6.35	6.48		R1	1.53	1.58	1.63	
A4	0.05	0.20	0.35		R2	1.53	1.58	1.63	
A5	2.54	--	--		b	0.99	1.04	1.09	
A6	4.00	--	--		e		1.27 BSC		
A7	4.00	--	--	7	TOLERANCES OF POSITION AND FORM				
D4		3.18 BSC			aaa	--	0.15	--	
D5	1.62	--	--		bbb	--	0.10	--	
D6	1.90	2.03	2.16						
E	--	--	9.14	7					
NOTE	1,2,3				NOTE	1,2,3			
REF.	14-029				REF.	14-016			
ISSUE	C				ISSUE	B			
SYMBOL	VARIATIONS (ALL DIMENSIONS IN MILLIMETERS)								
	AA			NOTE	AB			NOTE	
	MIN.	NOM.	MAX.		MIN.	NOM.	MAX.		
D	105.28	105.41	105.54	6					
D1	97.66	97.79	97.92						
D2		91.04 BSC							
D3		45.52 BSC							
N		128							
ccc	TOLERANCES OF POSITION AND FORM				TOLERANCES OF POSITION AND FORM				
	--	0.30	--	5					
NOTE	1,2,3								
REF.	14-013								
ISSUE	A								
JEDEC SOLID STATE PRODUCT OUTLINES		TITLE PLUGGABLE DUAL INLINE MODULE, 1.27 LEAD CENTERS			ISSUE C	DATE SEPT 97	M0-167	SHEET 3 OF 4	

NOTES:

1 DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5M-1994

2 ALL DIMENSIONS IN MILLIMETERS.

3 OPPOSING TABS (CONTACTS) ON EACH SIDE OF THE CARD ARE ELECTRICALLY ISOLATED FROM EACH OTHER.

4 CARD THICKNESS INCLUDES TAB PLATING AND/OR METALLIZATION.

5 STRAIGHTNESS REQUIREMENT APPLIES TO AREA FROM THE BOTTOM OF THE CARD TO A6/A7

6 N IS THE NUMBER OF CIRCUIT TABS (CONTACTS).

7 DIMENSION APPLICABLE WHEN COMPONENTS ARE MOUNTED ON BOTH SIDES OF THE CARD.

8 EARS ARE OPTIONAL. BUT WHEN USED MUST BE AS DIMENSIONED.

9. EDGE OF CONTACT PADS SPECIFIED BY THE KEEP OUT ZONE SHALL BE FREE OF BURRS AND EXTERNAL TIE BARS.

APPLICATION NOTE:

THE FOLLOWING PLATING REQUIREMENTS ARE SUGGESTED: CONTACT PAD-GOLD PLATING $0.76\mu\text{M}$ MINIMUM OVER NICKEL PLATING $2\mu\text{M}$ MINIMUM.

JEDEC SOLID STATE PRODUCT OUTLINES	TITLE PLUGGABLE DUAL INLINE MODULE, 127 LEAD CENTERS	ISSUE C	DATE SEPT 97	M0-167	SHEET 4 OF 4
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